

# 5N40

**Power MOSFET**

## 5A, 400V N-CHANNEL POWER MOSFET

■ DESCRIPTION

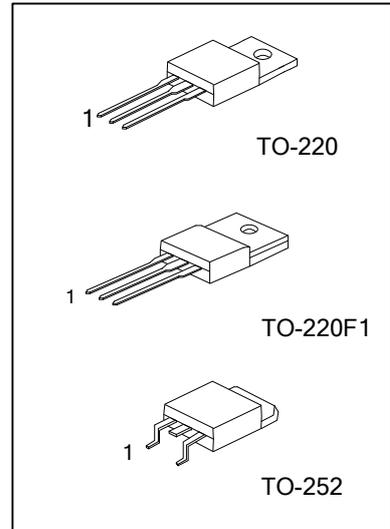
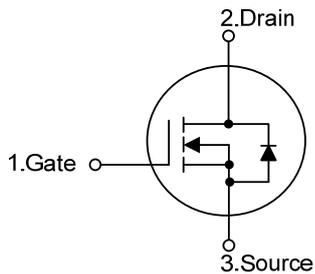
The **5N40** is an N-channel mode power MOSFET using' s advanced technology to provide customers with planar stripe and DMOS technology. This technology specializes in allowing a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The **5N40** is universally applied in electronic lamp ballast based on half bridge topology and high efficient switched mode power supply.

■ FEATURES

- \*  $R_{DS(ON)} < 1.2\Omega @ V_{GS} = 10V$
- \* High switching speed
- \* 100% avalanche tested

■ SYMBOL



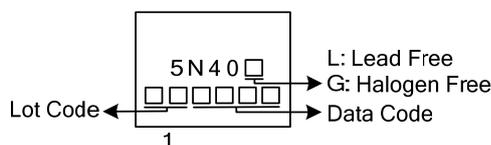
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
5N40L-TA3-T	5N40G-TA3-T	TO-220	G	D	S	Tube
5N40L-TF1-T	5N40G-TF1-T	TO-220F1	G	D	S	Tube
5N40L-TN3-R	5N40G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>5N40L-TA3-T</p> <p>(1)Packing Type</p> <p>(2)Package Type</p> <p>(3)Lead Free</p>	<p>(1) T: Tube, R: Tape Reel</p> <p>(2) TA3: TO-220, TF1: TO-220F1, TN3: TO-252</p> <p>(3) L: Lead Free, G: Halogen Free</p>
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■ MARKING



■ ABSOLUTE MAXIMUM RATINGS ( $T_C=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	400	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Drain Current	Continuous ( $T_C=25^\circ\text{C}$ )	$I_D$	5	A
	Pulsed (Note 2)	$I_{DM}$	20	A
Avalanche Current (Note 2)		$I_{AR}$	5	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	300	mJ
	Repetitive (Note 2)	$E_{AR}$	7.3	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Power Dissipation	TO-220	$P_D$	69	W
	TO-220F1		38	W
	TO-252		54	W
Junction Temperature		$T_J$	+150	$^\circ\text{C}$
Storage Temperature		$T_{STG}$	-55~+150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature

3.  $L = 21.5\text{mH}$ ,  $I_{AS} = 5\text{A}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$

4.  $I_{SD} \leq 5\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

■ THERMAL DATA

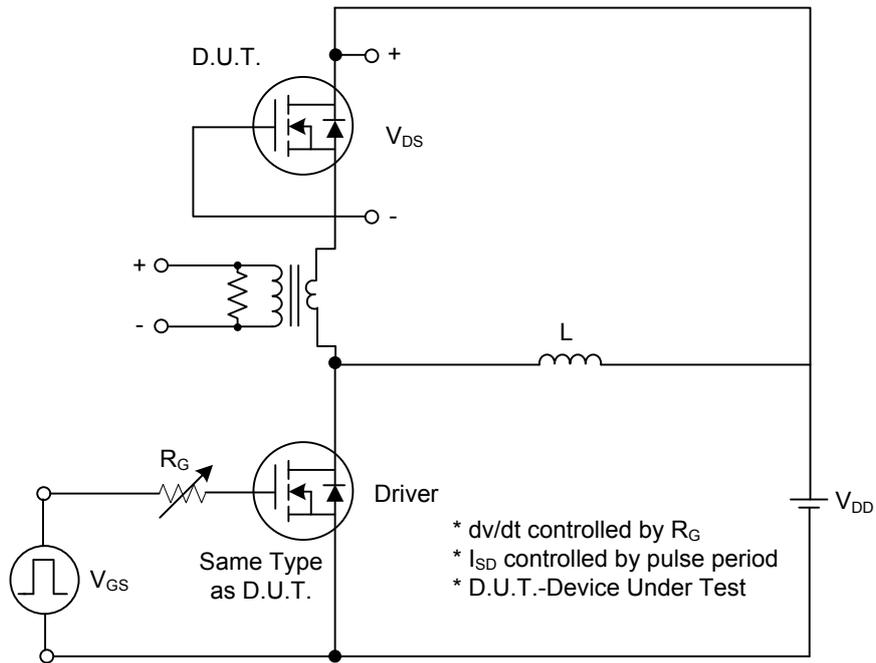
PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-220F1	$\theta_{JA}$	62.5	$^\circ\text{C}/\text{W}$
	TO-252		110	
Junction to Case	TO-220	$\theta_{JC}$	1.8	$^\circ\text{C}/\text{W}$
	TO-220F1		3.25	
	TO-252		2.13	

■ ELECTRICAL CHARACTERISTICS ( $T_c=25^\circ\text{C}$ , unless otherwise noted)

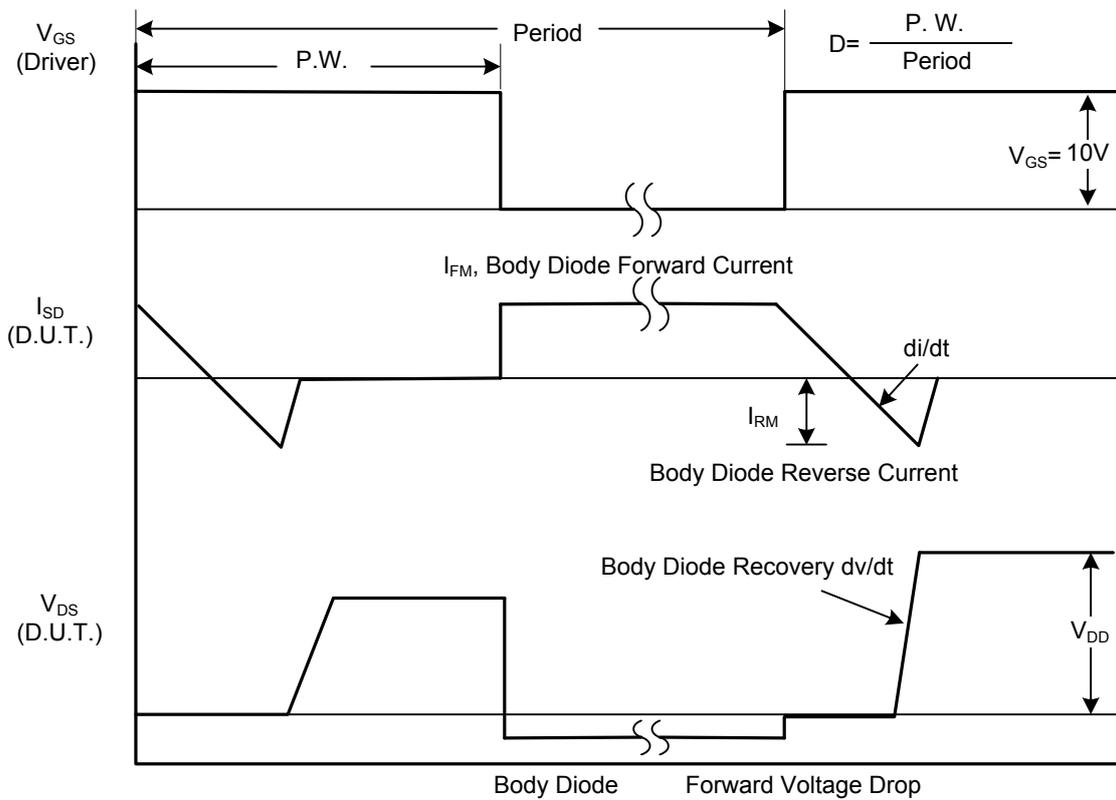
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$I_D=250\mu\text{A}$ , $V_{GS}=0\text{V}$	400			V
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	Reference to $25^\circ\text{C}$ , $I_D=250\mu\text{A}$		0.4		$\text{V}/^\circ\text{C}$
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=400\text{V}$ , $V_{GS}=0\text{V}$			1	$\mu\text{A}$
Gate- Source Leakage Current	Forward	$V_{GS}=+30\text{V}$ , $V_{DS}=0\text{V}$			+100	nA
	Reverse	$V_{GS}=-30\text{V}$ , $V_{DS}=0\text{V}$			-100	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_D=250\mu\text{A}$	2.0		4.0	V
Static Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10\text{V}$ , $I_D=2.5\text{A}$		0.96	1.2	$\Omega$
<b>DYNAMIC PARAMETERS</b>						
Input Capacitance	$C_{ISS}$	$V_{GS}=0\text{V}$ , $V_{DS}=25\text{V}$ , $f=1.0\text{MHz}$		480	625	pF
Output Capacitance	$C_{OSS}$			80	105	pF
Reverse Transfer Capacitance	$C_{RSS}$			15	20	pF
<b>SWITCHING PARAMETERS</b>						
Total Gate Charge	$Q_G$	$V_{GS}=10\text{V}$ , $V_{DS}=320\text{V}$ , $I_D=5\text{A}$ (Note 1, 2)		18	24	nC
Gate to Source Charge	$Q_{GS}$			2.2		nC
Gate to Drain Charge	$Q_{GD}$			9.7		nC
Turn-ON Delay Time	$t_{D(ON)}$	$V_{DD}=200\text{V}$ , $I_D=5\text{A}$ , $R_G=25\Omega$ (Note 1, 2)		12	35	ns
Rise Time	$t_R$			46	100	ns
Turn-OFF Delay Time	$t_{D(OFF)}$			50	110	ns
Fall-Time	$t_F$			48	105	ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Body-Diode Continuous Current	$I_S$				5	A
Maximum Body-Diode Pulsed Current	$I_{SM}$				20	A
Drain-Source Diode Forward Voltage	$V_{SD}$	$I_S=5\text{A}$ , $V_{GS}=0\text{V}$			1.4	V
Body Diode Reverse Recovery Time	$t_{rr}$	$I_S=5\text{A}$ , $V_{GS}=0\text{V}$ , $dI_F/dt=100\text{A}/\mu\text{s}$ (Note 1)		263		ns
Body Diode Reverse Recovery Charge	$Q_{RR}$				1.9	

Notes: 1. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$   
2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

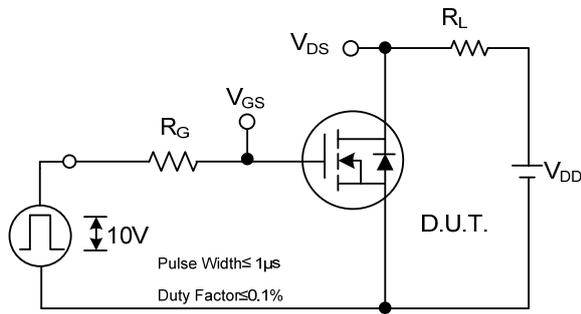


Peak Diode Recovery  $dv/dt$  Test Circuit

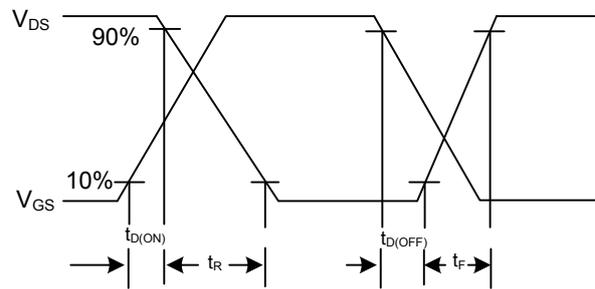


Peak Diode Recovery  $dv/dt$  Waveforms

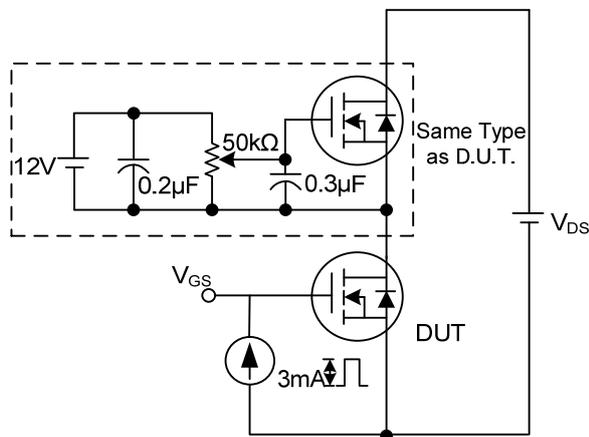
## TEST CIRCUITS AND WAVEFORMS (Cont.)



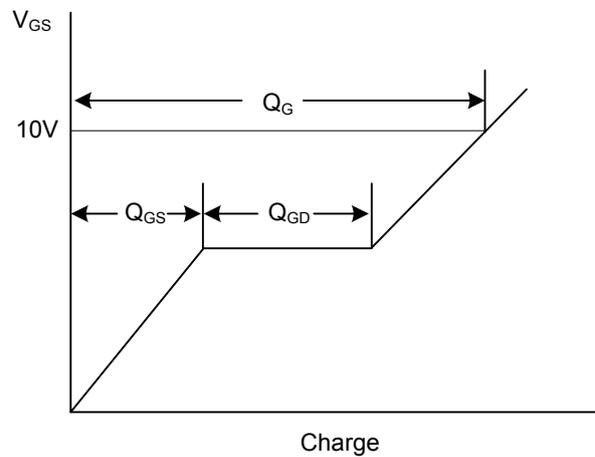
Switching Test Circuit



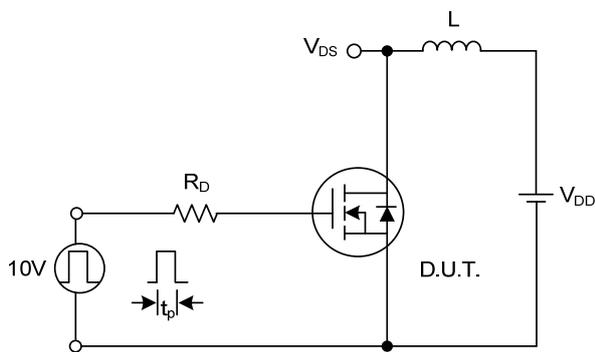
Switching Waveforms



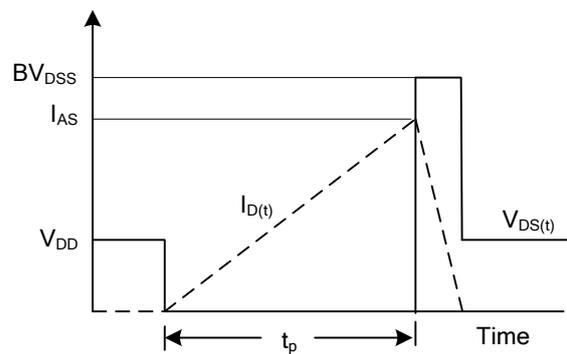
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS

